



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Part Number: APTB1612LVBDSEKJ3C

Blue
Hyper Red

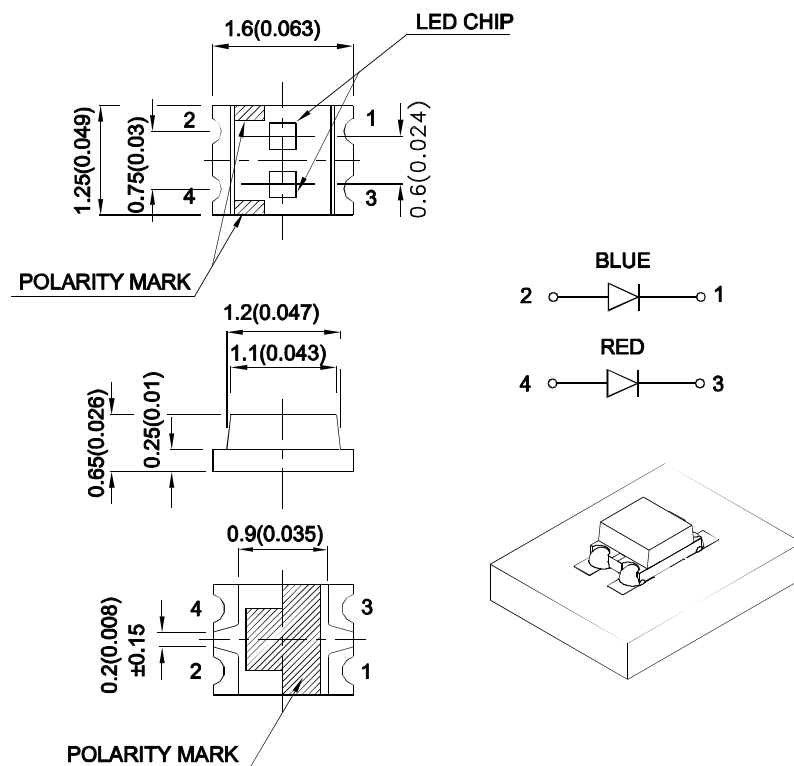
Features

- 1.6mmx1.25mm SMD LED, 0.65mm thickness.
- Bi-color, low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Low current IF=2mA operating.
- RoHS compliant.

Descriptions

- The Blue source color devices are made with InGaN Light Emitting Diode.
- The Hyper Red device is based on light emitting diode chip made from AlGaInP.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.2(0.008)$ unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.



Selection Guide

| Part No. | Emitting Color (Material) | Lens Type | Iv (mcd) [2] @ 2mA | | Viewing Angle [1] |
|---------------------|---------------------------|-------------|-----------------------|------|----------------------|
| | | | Min. | Typ. | 2θ1/2 |
| APT B1612LVBDSEKJ3C | Blue (InGaN) | Water Clear | 10 | 20 | 120° |
| | | | *10 | *20 | |
| | | | 50 | 120 | |
| | Hyper Red (AlGaInP) | | *20 | *40 | |

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous Flux: +/-15%.

* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Emitting Color | Min. | Typ. | Max. | Units | Test Conditions |
|--------|--------------------------|-------------------|------------|-------------|------------|-------|-----------------|
| λpeak | Peak Wavelength | Blue Hyper Red | | 465 640 | | nm | IF=2mA |
| λD [1] | Dominant Wavelength | Blue Hyper Red | | 470 625 | | nm | IF=2mA |
| Δλ1/2 | Spectral Line Half-width | Blue Hyper Red | | 22 20 | | nm | IF=2mA |
| C | Capacitance | Blue Hyper Red | | 100 27 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Blue Hyper Red | 2.2 1.5 | 2.65 1.8 | 3.0 2.1 | V | IF=2mA |
| IR | Reverse Current | Blue Hyper Red | | | 50 10 | uA | VR = 5V |

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

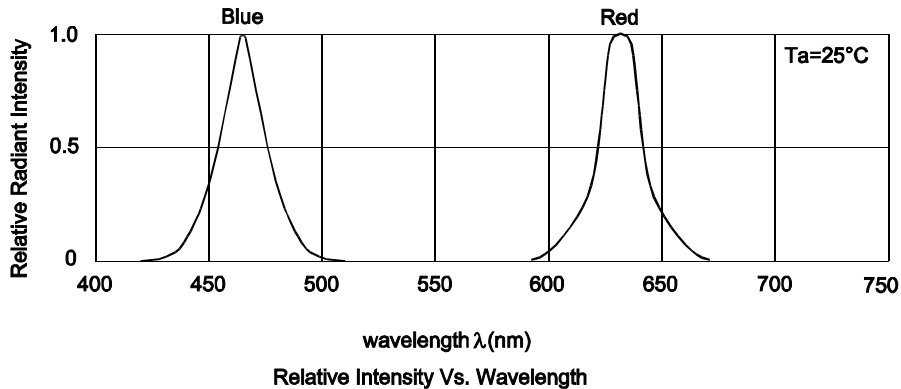
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

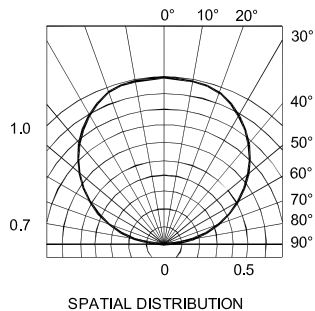
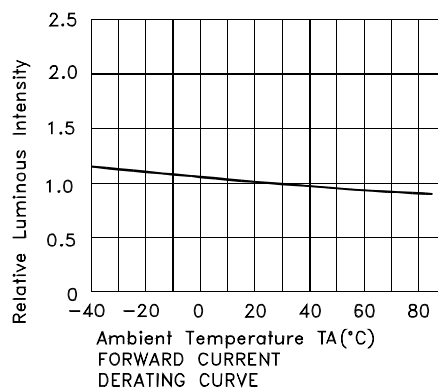
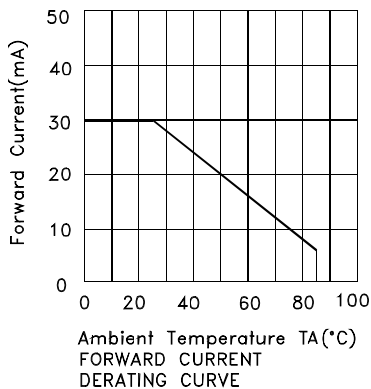
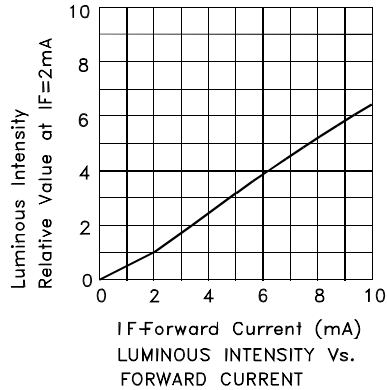
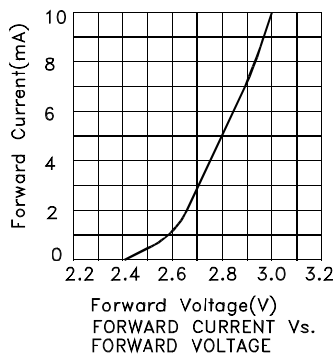
| Parameter | Blue | Hyper Red | Units |
|-----------------------------------------|----------------|-----------|-------|
| Power dissipation | 90 | 63 | mW |
| DC Forward Current | 30 | 30 | mA |
| Peak Forward Current [1] | 100 | 150 | mA |
| Electrostatic Discharge Threshold (HBM) | 250 | 3000 | V |
| Reverse Voltage | 5 | | V |
| Operating Temperature | -40°C To +85°C | | |
| Storage Temperature | -40°C To +85°C | | |

Note:

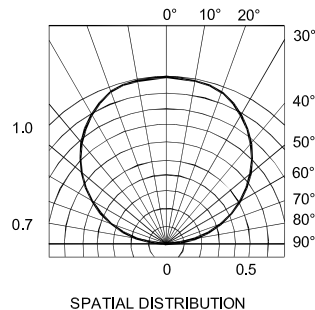
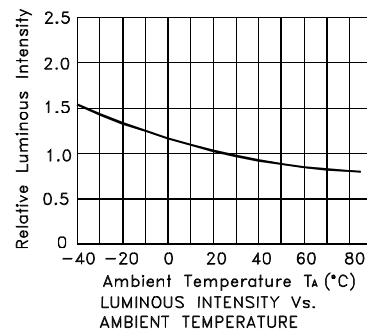
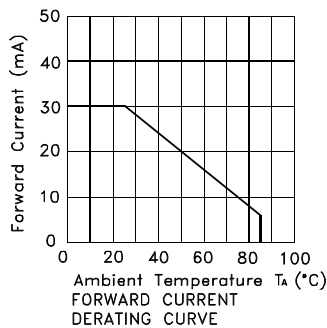
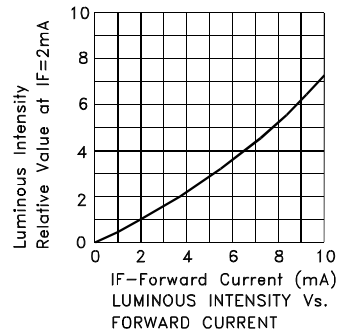
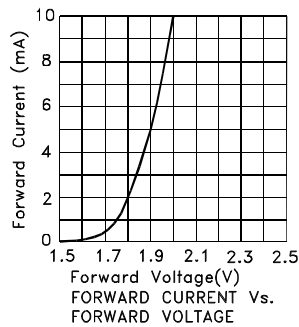
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



APT1612LVBDSKJ3C
Blue



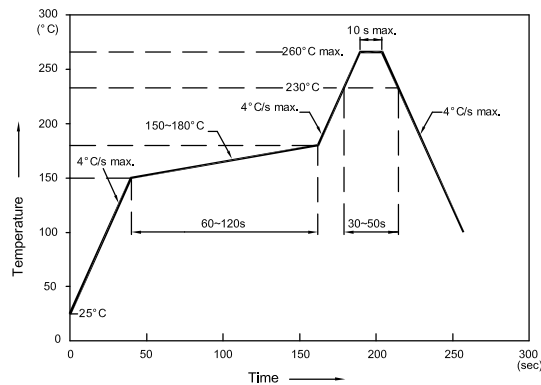
Hyper Red



APTB1612LVBDSEKJ3C

Reflow soldering is recommended and the soldering profile is shown below.
Other soldering methods are not recommended as they might cause damage to the product.

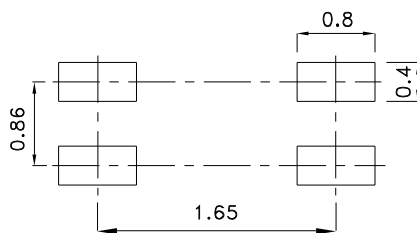
Reflow Soldering Profile For Lead-free SMT Process.



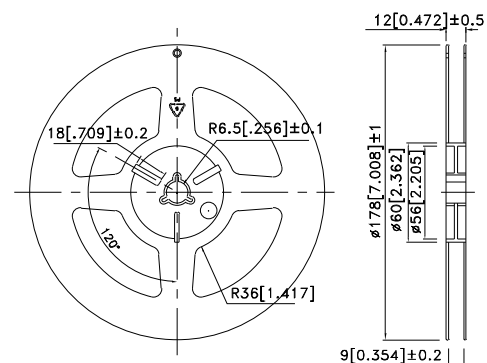
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

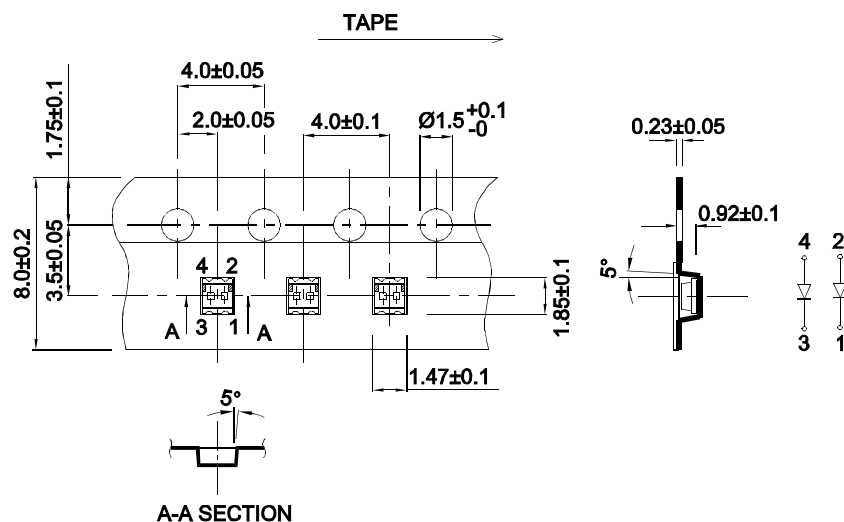
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension

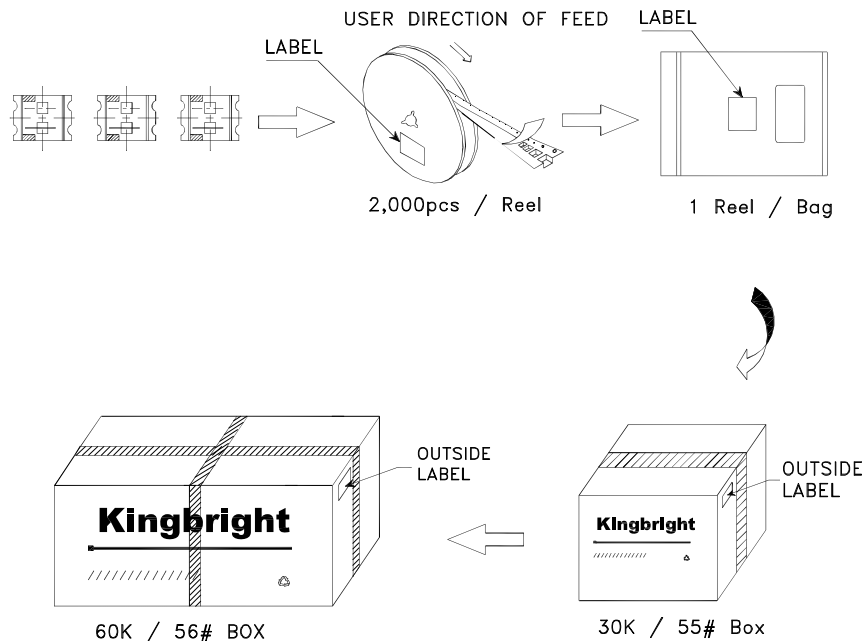



Tape Dimensions (Units : mm)



PACKING & LABEL SPECIFICATIONS

APTB1612LVBDSEKJ3C



| | |
|--------------------------------------------------------------------------------------------------------------------------|------------------------------------------|
| Kingbright | |
| P/N0: APTB1612xxx | |
| QTY: 2,000 pcs | Q.C. |
| S/N: XXXX | <div>Q C XX XX XXXX PASSED</div> |
| CODE: XXX | |
| LOT NO: | |
|  xxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxx | |
| RoHS Compliant | |

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